

RoHS

COMPLIANT

HALOGEN

FREE

P-Channel 20-V (D-S) MOSFET

| MOSFET PRODUCT SUMMARY | | | | | |
|------------------------|------------------------------------|---------------------------------|-----------------------|--|--|
| V _{DS} (V) | R_{DS(on)} (Ω) | I _D (A) ^a | Q _g (Typ.) | | |
| | 0.035 at V _{GS} = - 10 V | - 5 ^e | | | |
| - 20 | 0.043 at V _{GS} = - 4.5 V | - 5 ^e | 10 nC | | |
| | 0.061 at V _{GS} = - 2.5 V | - 4.8 | | | |

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested •
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- · Load Switch
- PA Switch
- DC/DC Converters

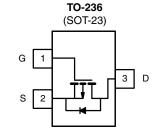
| ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted) | | | | | | | |
|---|-----------------------------------|----------------|-----------------------|---|--|--|--|
| Parameter | Symbol | Limit | Unit | | | | |
| Drain-Source Voltage | V _{DS} | - 20 | V | | | | |
| Gate-Source Voltage | V _{GS} | ± 12 | v | | | | |
| | T _C = 25 °C | | - 5 ^e | | | | |
| Continuous Drain Current (T ₁ = 150 °C) | T _C = 70 °C | I _D | - 4.8 | | | | |
| continuous Diatri current (1) = 100 °C) | T _A = 25 °C | טי | - 4.5 ^{b, c} | | | | |
| | T _A = 70 °C | | - 3.5 ^{b, c} | A | | | |
| Pulsed Drain Current | I _{DM} | - 18 | | | | | |
| Continuous Source-Drain Diode Current | T _C = 25 °C | ا _S | - 2.1 | | | | |
| Continuous Source-Drain Diode Guneni | T _A = 25 °C | '8 | - 1.0 ^{b, c} | | | | |
| | T _C = 25 °C | | 2.5 | | | | |
| Maximum Power Dissipation | T _C = 70 °C | PD | 1.6 | w | | | |
| | T _A = 25 °C | ١D | 1.25 ^{b, c} | | | | |
| | T _A = 70 °C | | 0.8 ^{b, c} | 7 | | | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | - 55 to 150 | °C | | | | |

| THERMAL RESISTANCE RATINGS | | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|--|
| Parameter | | Symbol | Typical | Maximum | Unit | | |
| Maximum Junction-to-Ambient ^{b, d} | ≤5 s | R _{thJA} | 75 | 100 | °C/W | | |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 40 | 50 | 0/11 | | |

Notes:

- a. Based on T_C = 25 °C. b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under steady state conditions is 166 °C/W.

e. Package limited.



STS2305A

| MOSFET SPECIFICATIONS | (T _J = 25 °C | , unless otherwise noted) | | | | | | |
|---|-------------------------|---|---------------------|--------|-------|-------|--|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | | |
| Static | | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{DS} = 0 V, I_{D} = -250 \mu A$ | - 20 | | | V | | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | L 050 ··· A | | - 13.4 | | mV/°C | | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = - 250 μΑ | | 2.9 | | | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 0.5 | | - 1.5 | V | | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 12 V$ | | | ± 100 | nA | | |
| Zava Cata Maltana Drain Ourrant | | $V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | _{GS} = 0 V | | - 1 | | | |
| Zero Gate Voltage Drain Current | IDSS | V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 55 °C | | | - 10 | μΑ | | |
| On-State Drain Current ^a | I _{D(on)} | V_{DS} \leq - 5 V, V_{GS} = - 4.5 V | - 18 | | | Α | | |
| | | V _{GS} = - 10 V, I _D = - 5.1 A | | 0.035 | | | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 4.5 V, I _D = - 4.5 A | | 0.043 | | Ω | | |
| | | V _{GS} = - 2.5 V, I _D = - 3.7 A | | 0.061 | | | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 5 V, I _D = - 5.1 A | | 15 | | S | | |
| Dynamic ^b | | | | | | • | | |
| Input Capacitance | C _{iss} | | | 835 | | | | |
| Output Capacitance | C _{oss} | V_{DS} = - 10 V, V_{GS} = 0 V, f = 1 MHz | | 180 | | pF | | |
| Reverse Transfer Capacitance | C _{rss} | | | 155 | | 1 | | |
| Total Cata Charge | Qg | $V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -5.1 \text{ A}$ | | 10 | | | | |
| Total Gate Charge | Qg | | | 6.4 | | | | |
| Gate-Source Charge | Q _{gs} | V_{DS} = - 10 V, V_{GS} = - 2.5 V, I_D = - 5.1 A | | 1.7 | | nC | | |
| Gate-Drain Charge | Q _{gd} | | | 3.4 | | 1 | | |
| Gate Resistance | Rg | f = 1 MHz | 0.9 | 4.4 | 8.8 | Ω | | |
| Turn-On Delay Time | t _{d(on)} | | | 22 | 33 | | | |
| Rise Time | t _r | V_{DD} = - 10 V, R_L = 2.4 Ω | | 20 | 30 | 1 | | |
| Turn-Off Delay Time | t _{d(off)} | I_D = - 4.1 Å, V_{GEN} = - 4.5 V, R_g = 1 Ω | | 28 | 42 | ns | | |
| Fall Time | t _f | | | 9 | 18 | 1 | | |
| Drain-Source Body Diode Characteris | tics | | | 1 | | | | |
| Quality Qual Design | | | | 1 | | | | |

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

Continuous Source-Drain Diode Current

Body Diode Reverse Recovery Time

Body Diode Reverse Recovery Charge

Pulse Diode Forward Current^a

Reverse Recovery Fall Time

Reverse Recovery Rise Time

Body Diode Voltage

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

T_C = 25 °C

I_S = - 4.1 A

 $I_F = -4.1 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{T}_J = 25 \text{ }^\circ\text{C}$

 I_S

I_{SM}

V_{SD}

t_{rr}

Q_{rr}

ta

t_b

- 2.1

- 20

- 1.2

35

20

- 0.8

23

12

15

8

А

٧

ns

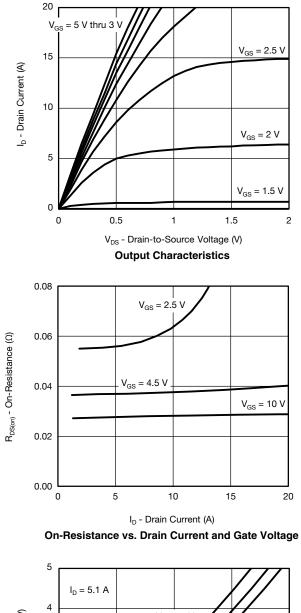
nC

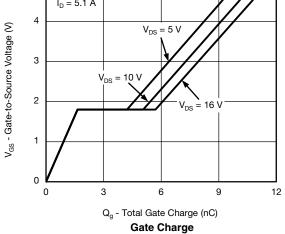
ns

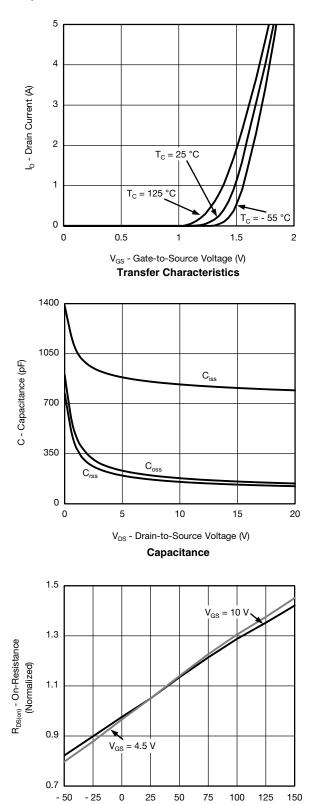
WWW VReomi



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





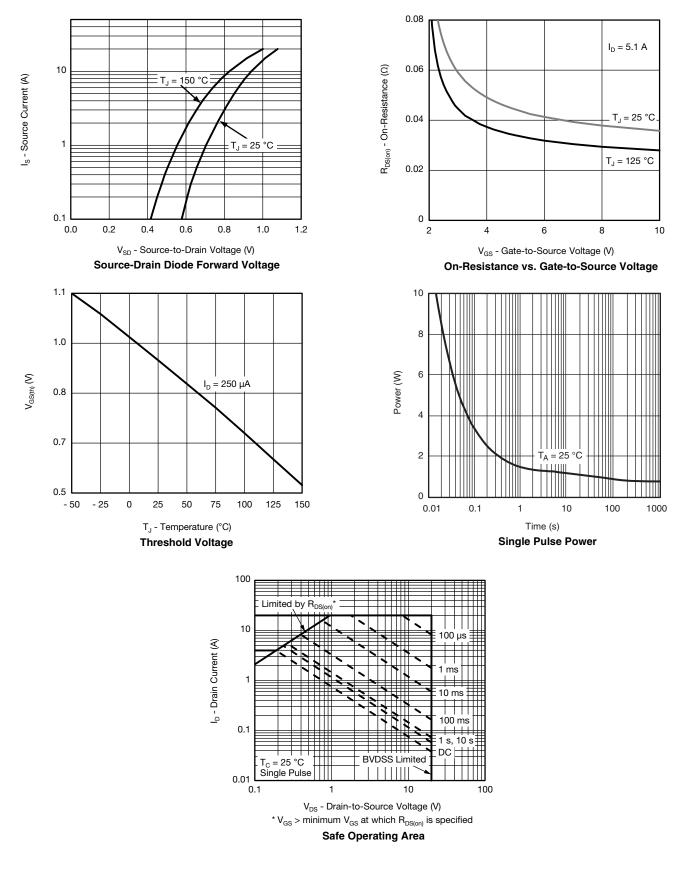


T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

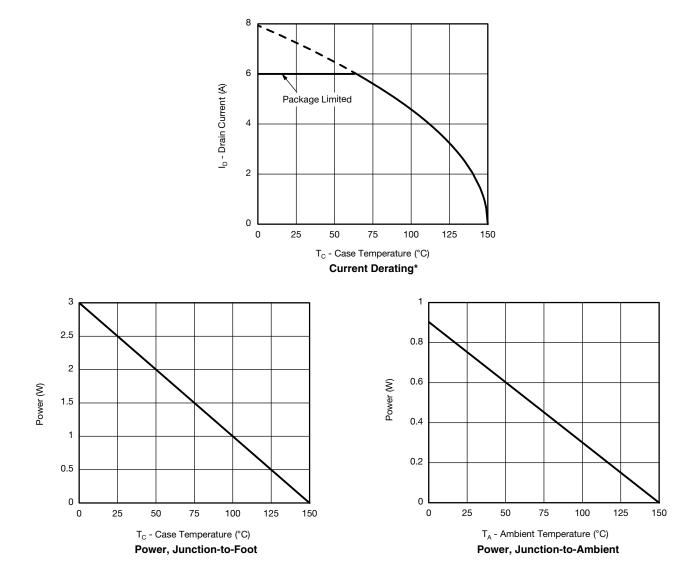


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





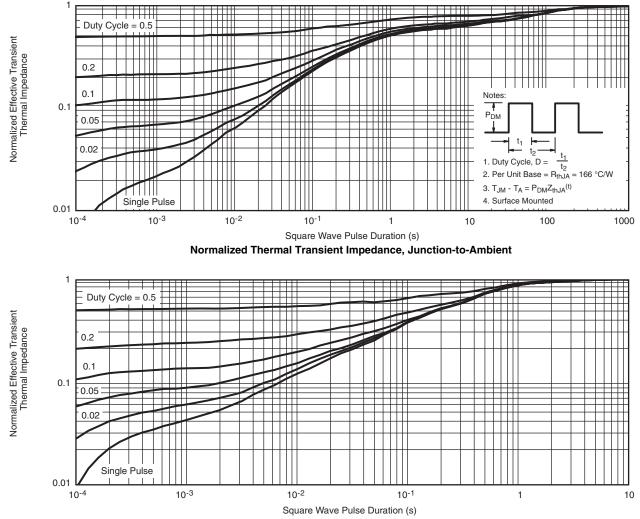
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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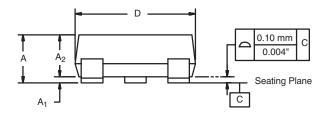


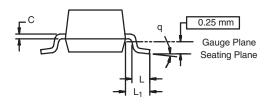
Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD



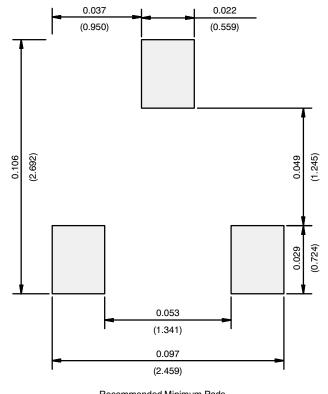




| Dim | MILLI | METERS | INCHES | | |
|--|----------|--------|---------------|-------|--|
| | Min | Мах | Min | Max | |
| Α | 0.89 | 1.12 | 0.035 | 0.044 | |
| A ₁ | 0.01 | 0.10 | 0.0004 | 0.004 | |
| A ₂ | 0.88 | 1.02 | 0.0346 | 0.040 | |
| b | 0.35 | 0.50 | 0.014 | 0.020 | |
| С | 0.085 | 0.18 | 0.003 | 0.007 | |
| D | 2.80 | 3.04 | 0.110 | 0.120 | |
| E | 2.10 | 2.64 | 0.083 | 0.104 | |
| E ₁ | 1.20 | 1.40 | 0.047 | 0.055 | |
| е | 0.9 | 5 BSC | SC 0.0374 Ref | | |
| e ₁ | 1.9 | 0 BSC | 0.0748 Ref | | |
| L | 0.40 | 0.60 | 0.016 | 0.024 | |
| L ₁ | 0.64 Ref | | 0.025 Ref | | |
| S | 0.50 Ref | | 0.020 Ref | | |
| q | 3° | 8° | 3° | 8° | |
| ECN: S-03946-Rev. K, 09-J DWG: 5479 | ul-01 | • | · | | |



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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